FY2024 First Quarter (Ended May 31, 2024) Financial Briefing

July 12, 2024

RORZE CORPORATION
(Code： 6323)
https://www.rorze.com/ir

Disclaimer

Regarding forward-looking statements

The business forecasts and other forward-looking statements contained in this document are based on judgments made in accordance with information currently available for our company and do not constitute a guarantee or promise of the accuracy or completeness of such information. The forecast is also subject to change without notice due to changes in economic conditions, industry competition, markets and other systems.

Data included in this document are stated as follows

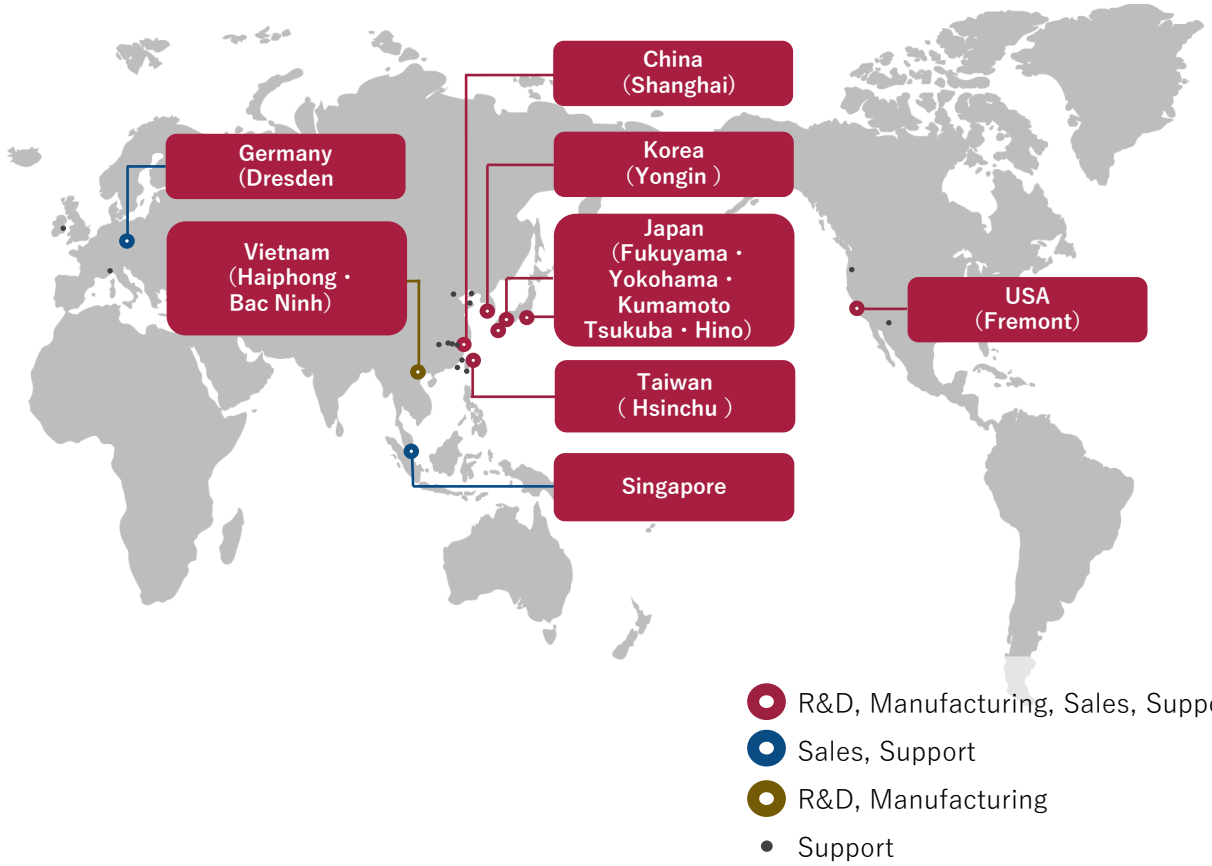
JPY values	:	Rounded down to the nearest unit
Percentages	:	Rounded to the nearest unit after calculated in units of 1 JPY
Fiscal year	:	Refer to the "fiscal year ended February 28, 2025" as "FY2024" or "FY'24,"
Accounting period	:	The accounting periods of the consolidated, head office, and domestic and overseas subsidiaries are as follows:

	Q1 (1st Quarter)	Q2 (2ndQuarter)	Q3 (3rd Quarter)	Q4 (4th Quarter)	Full-year
Consolidated・RORZE ・Domestic subsidiaries	Mar.～May.	Jun.～Aug.	Sep.～Nov.	Dec.～ The following Feb.	Mar.～ The following Feb.
Overseas subsidiaries	Jan.～Mar.	Apr.～Jun.	Jul.～Sep.	Oct.～Dec.	Jan.～Dec.

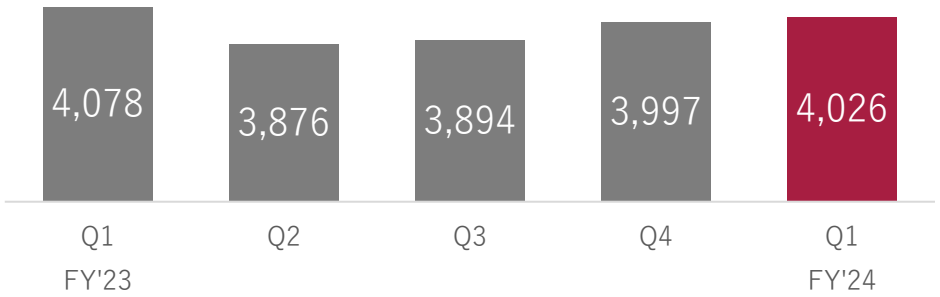
Company Profile

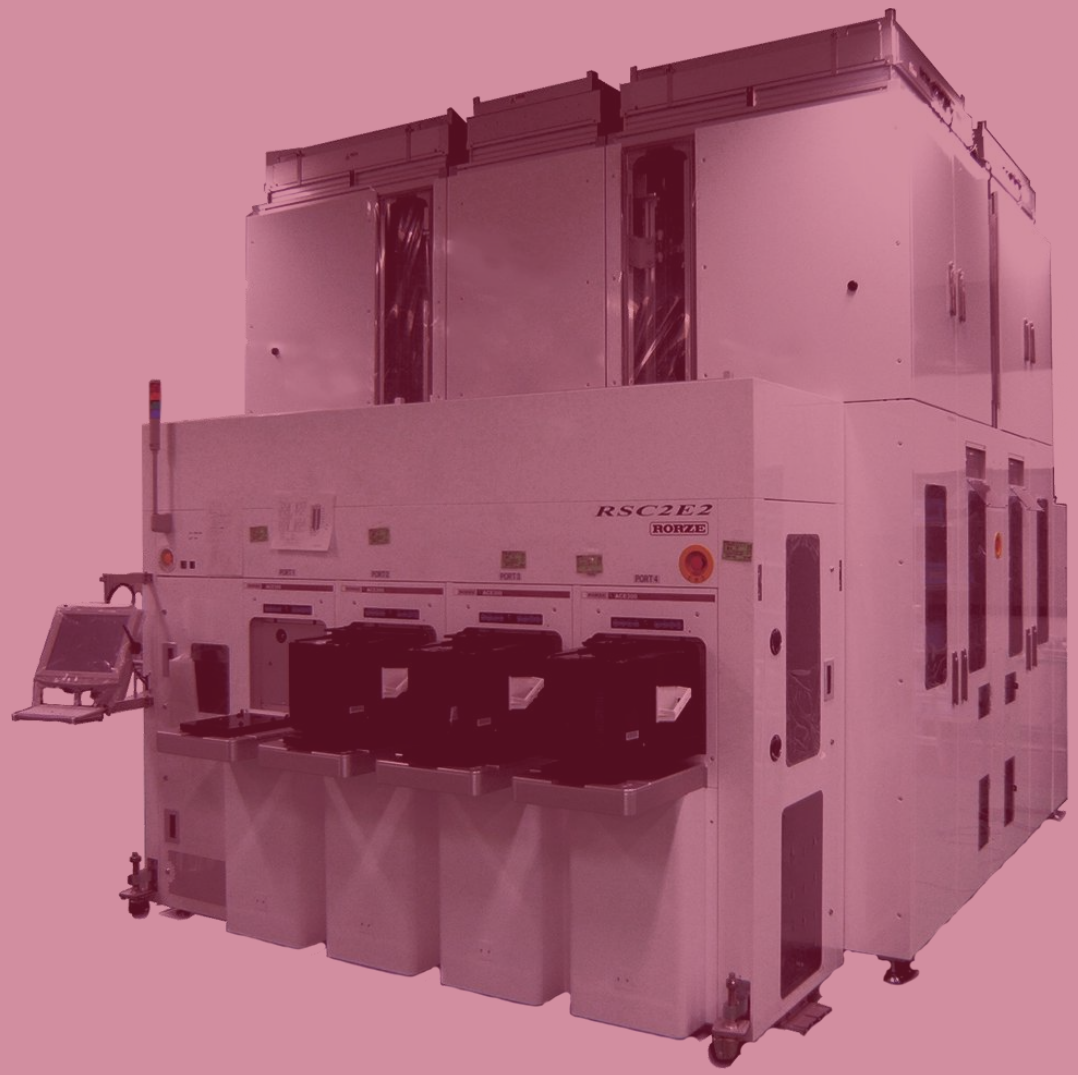
Name	RORZE CORPORATION
Listed Market	Tokyo Stock Exchange Prime Market (Securities code：6323)
Head Office	1588-2 Michinoue Kannabe-cho, Fukuyama-shi, Hiroshima
Establishment	March 30, 1985
Capital	982 million JPY
Business	Development, design, manufacturing, and sales of automation system for semiconductor/FPD production and life science automation products
Employees	Consolidated ： 4,026　Non-consolidated： 248 （As of May 31, 2024）
Locations	Japan： Fukuyama・Yokohama・Kumamoto・Tsukuba・Hino Overseas： USA / Vietnam / Taiwan / Korea / Singapore/ China / Germany

Global Network



Changes in number of employees (consolidated)





FY2024
First Quarter
(March 1, 2024～May 31, 2024)
Consolidated Business Results

Summary of Q1 FY2024

- Semi Sales growth, mainly in China, increased revenue, and with foreign exchange gains achieved significant profit increase

		YOY
Net sales	**29,288** million JPY	+75.5%
Operating profit	**8,748** million JPY	+85.4%
Ordinary profit	**11,361** million JPY	+118.1%
Profit attributable to owners of parent	**8,774** million JPY	+146.7%

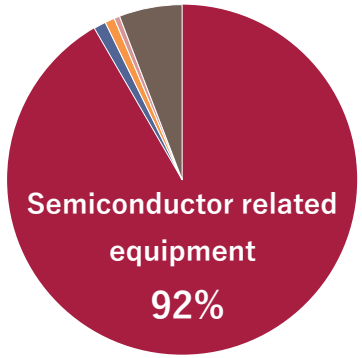
Exchange rate

(Yen/USD)

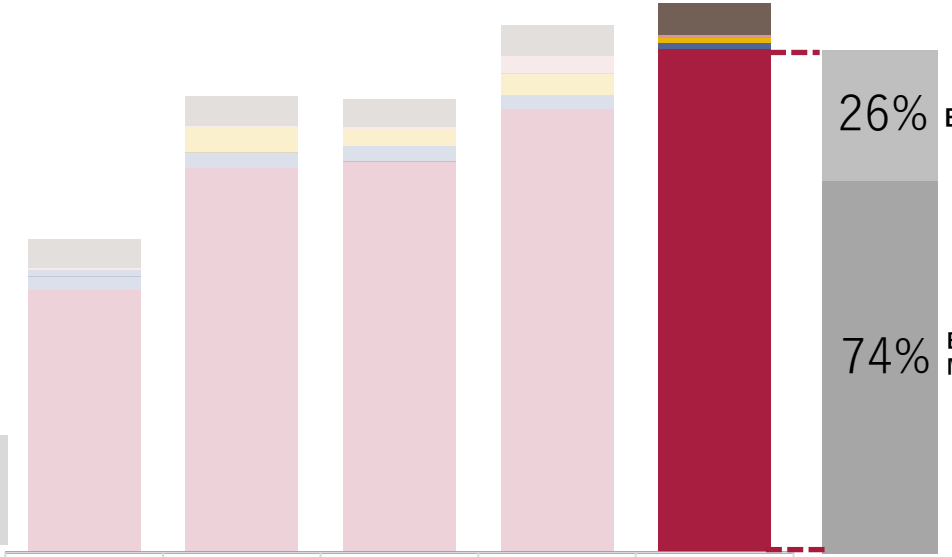
Q1 FY'23	Q1 FY'24	FY'24 Forecast
133	147	144

※ Starting from this fiscal year, performance forecasts and actual results are based on the average rate for the period.

Sale composition ratio



Quarterly Sales



(Million JPY)	Q1 FY'23	Q2	Q3	Q4	Q1 FY'24
Service/Parts※	1,543	1,582	1,490	1,638	1,705
Life science	100	52	148	919	152
FPD	346	1,368	846	1,152	262
Analysis device	715	805	849	742	331
Semi	13,987	20,489	20,836	23,632	26,836

※ From the current fiscal year, "motor control equipment" is included in “Service/Parts etc.”.

FY2024 Q1 business result

- Semi Sales drove revenue growth, and with foreign exchange gains increased profit

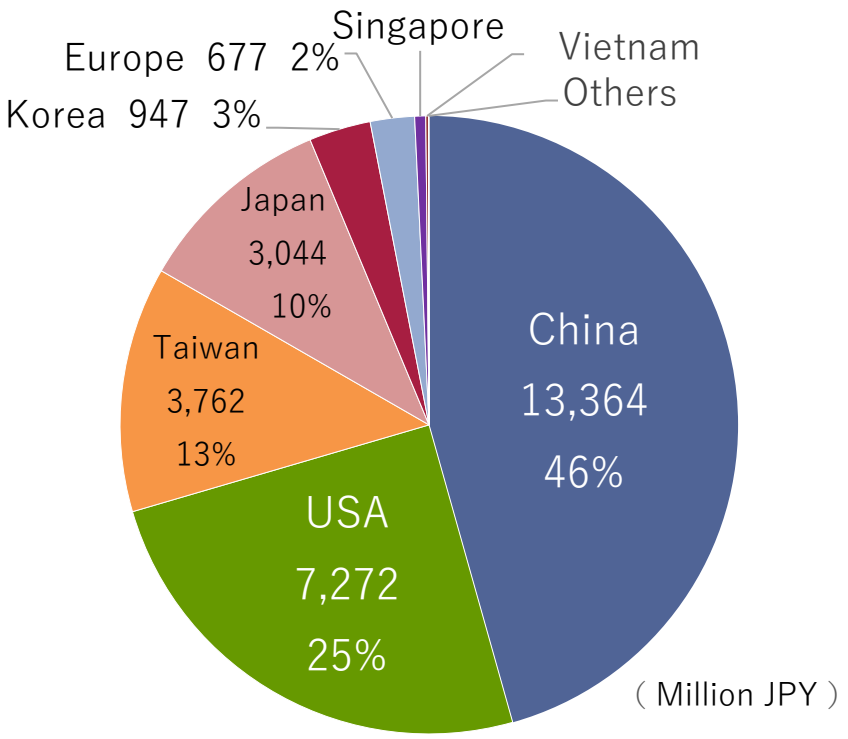
(Million JPY)

	FY'24 Q1 Achievements	FY'23 Q1 (Previous year)	YoY (%)	FY'23 Q4 (Last quarter)	QoQ (%)
Net Sales	29,288	16,693	175.5	28,085	104.3
Semi	26,836	13,987	191.9	23,632	113.6
Analysis device	331	715	46.3	742	44.7
FPD	262	346	75.7	1,152	22.8
Life science	152	100	152.1	919	16.6
※Service/Parts etc.	1,705	1,543	110.5	1,638	104.1
Operating Profit	8,748	4,718	185.4	8,375	104.4
Ordinary Profit	11,361	5,208	218.1	5,750	197.6
Attributable to parent company shareholders Quarterly (current) Net Profit	8,774	3,557	246.7	4,088	214.6

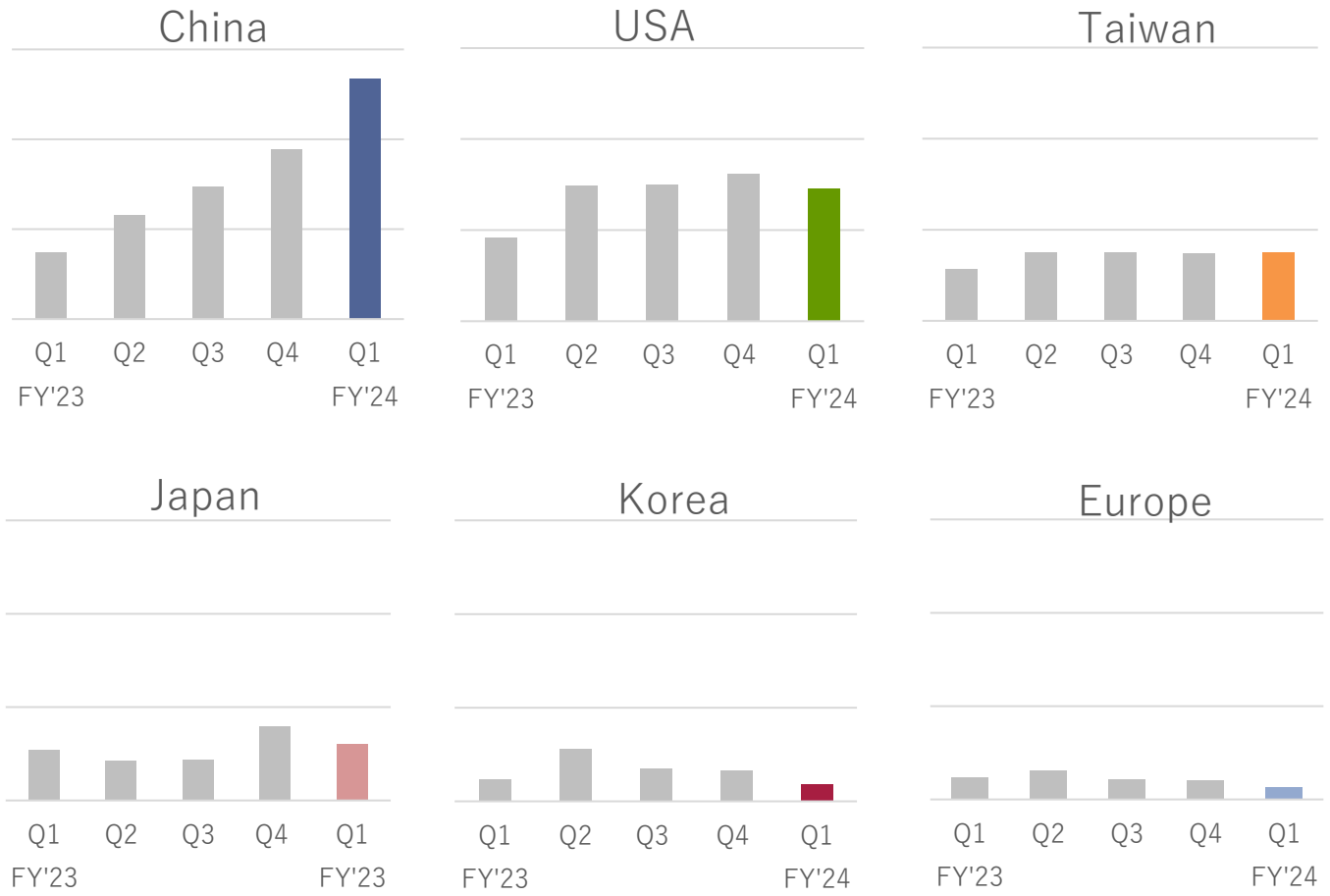
※ From the current fiscal year, "motor control equipment" is included in “Service/Parts etc.”.

Net sales by regions

- Semi sales to China have consecutively increased since Q1 of previous year, and became the top, surpassing the US



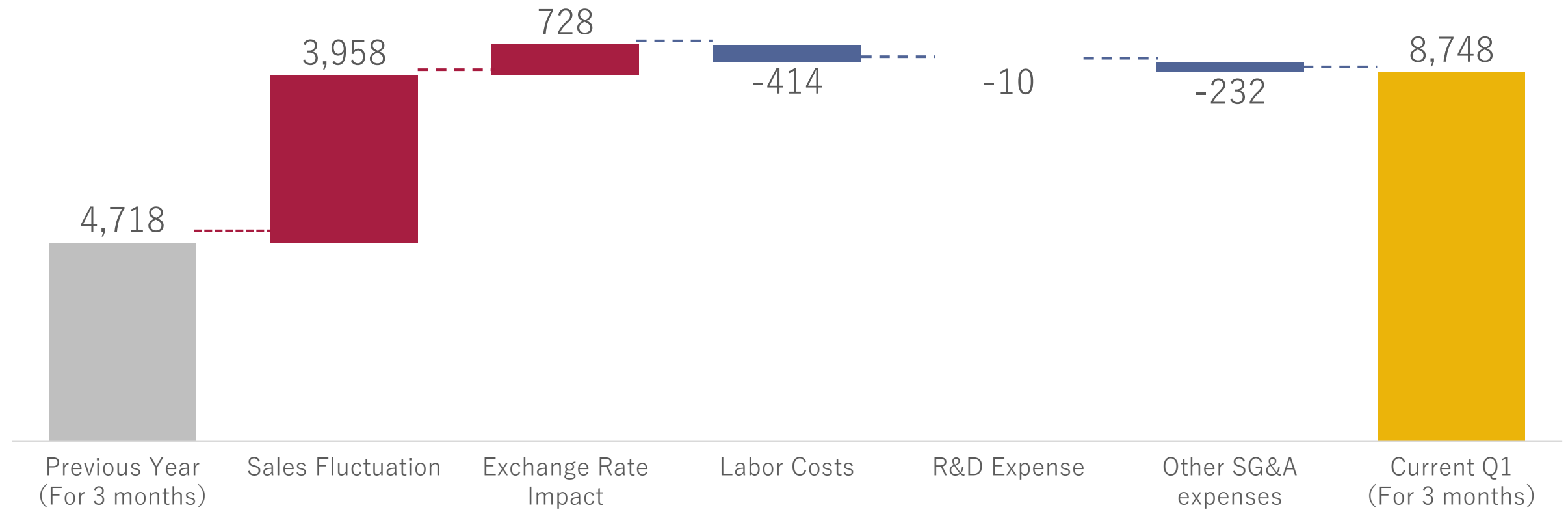
※ “Net sales by region" is calculated based on the head quarter of each customer locates.



Operating profit

- High Semi sales drove the profit increase

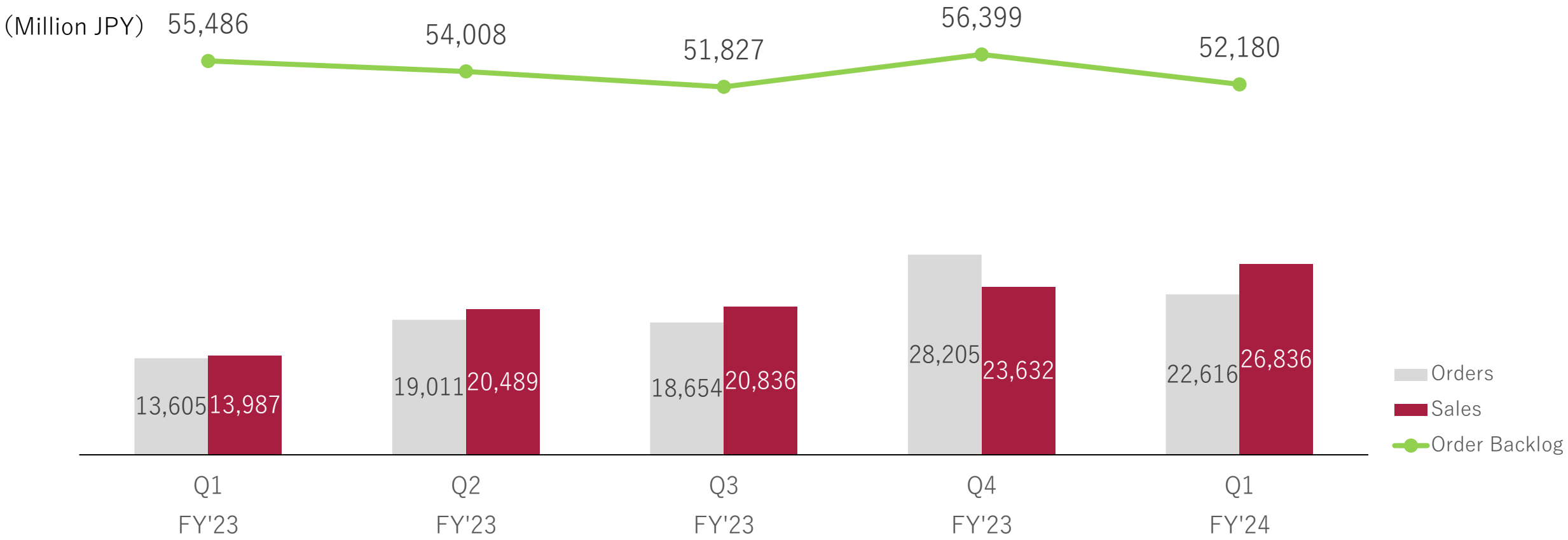
(Million JPY)



Trends in orders, sales, and backlog

Semiconductor related equipment

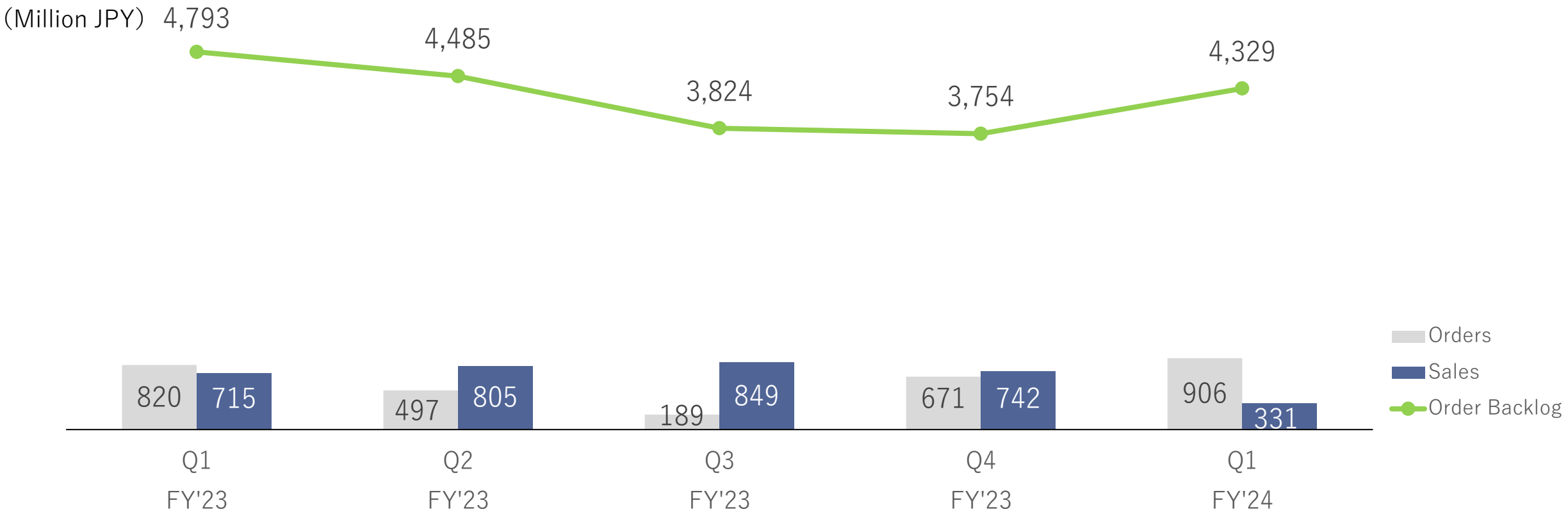
・Orders, declining QoQ in reaction from the previous quarter concentration, remained high and sales growth reduced backlog



Trends in orders, sales, and backlog

Analysis equipment

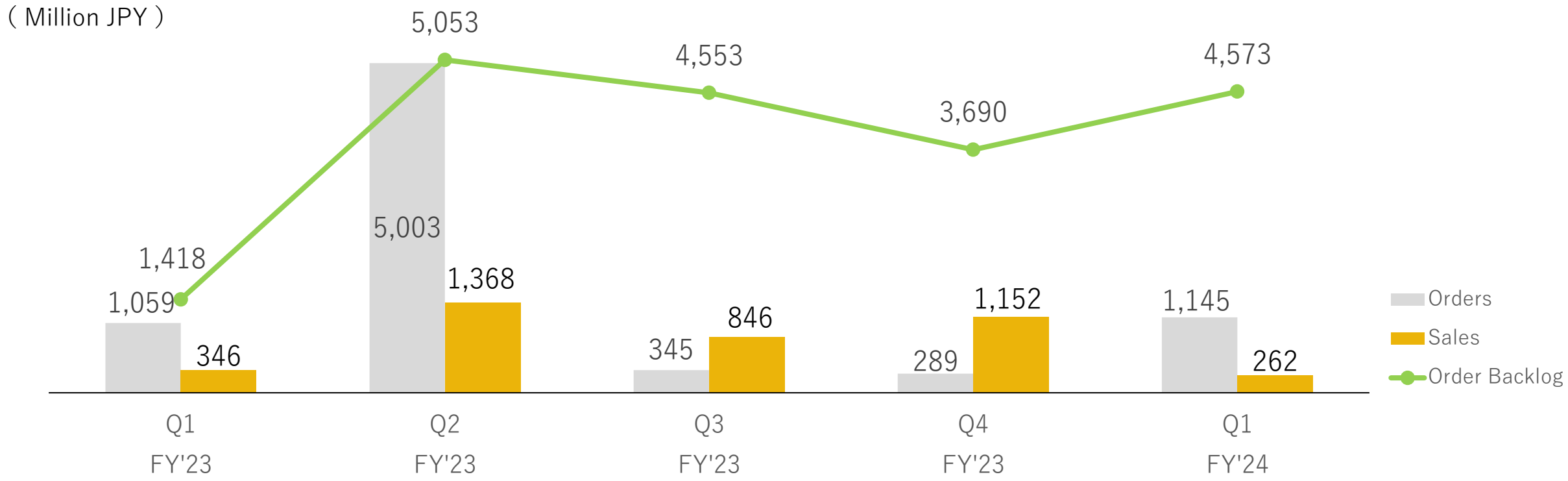
・Orders of main product increased, while equipment installation and acceptance push-out decreased the sales amount



Trends in orders, sales, and backlog

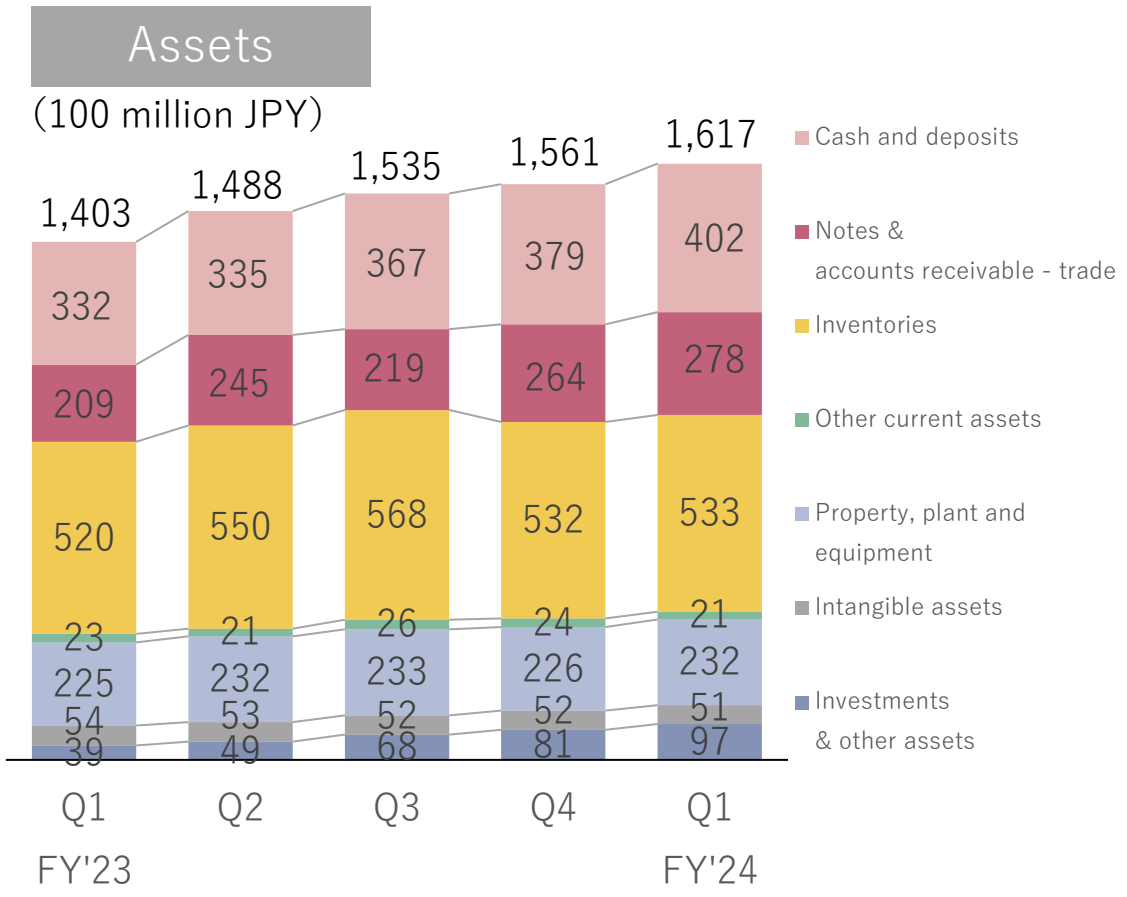
FPD

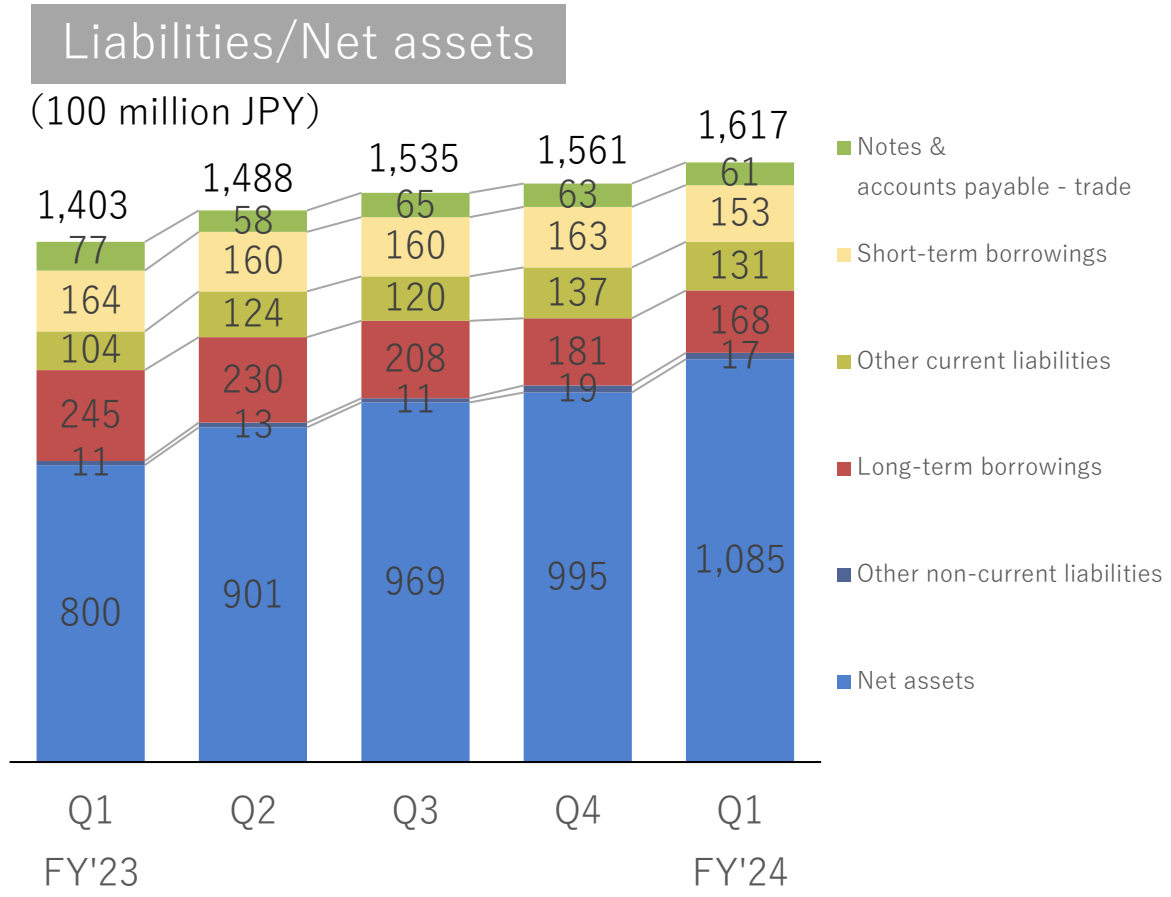
・Sales declined under slow progress in deliveries, orders were solid in the current quarter
・The bulk order of large substrate transfer system ordered in Q2 FY'23 is to be delivered in next quarter

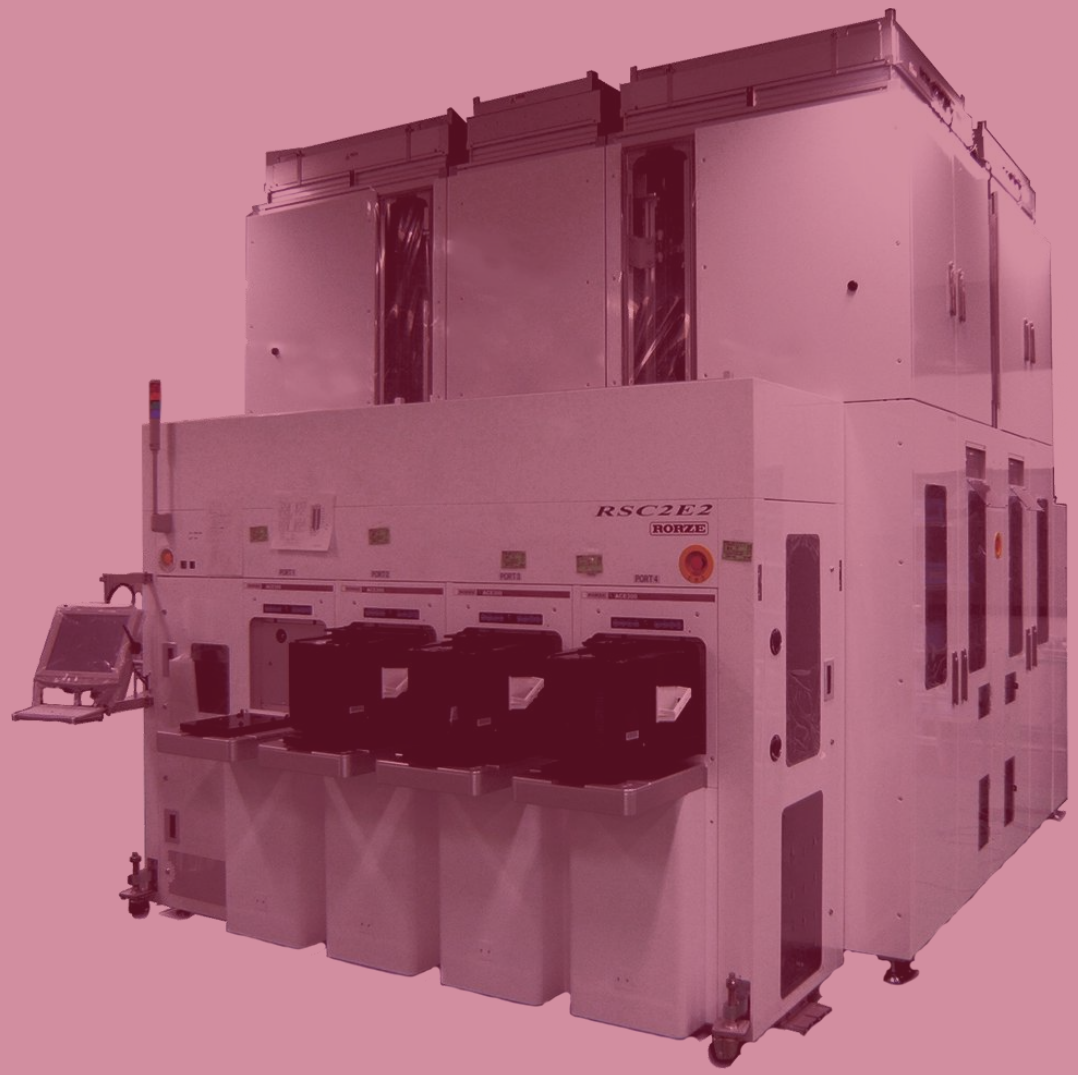


Consolidated balance sheet

- Inventory level remains, offsetting reducing activity by procurement for high level orders







FY2024
Business Forecast

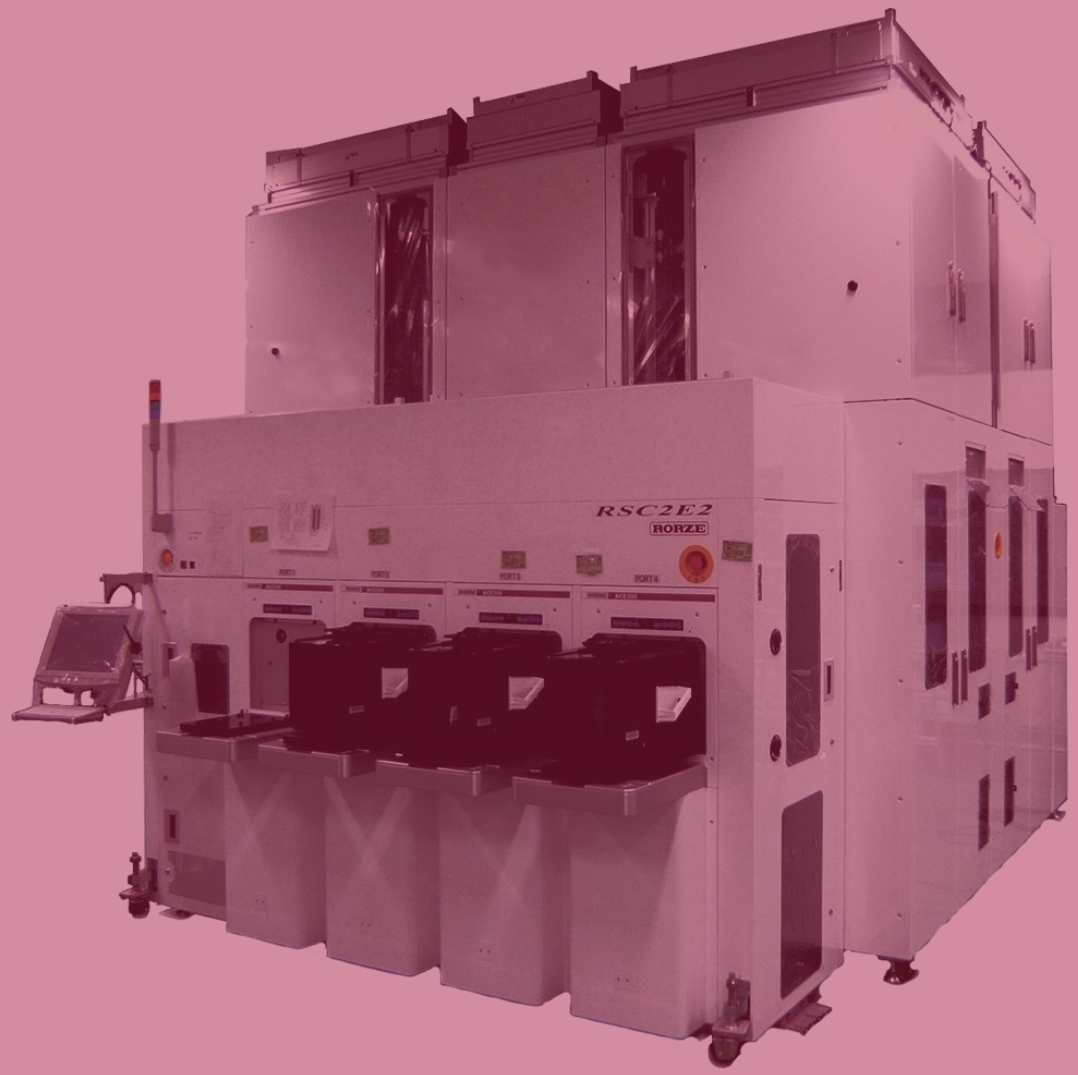
Future outlook and forecast for FY2024

- Forecast is unchanged based on solid business outlook in China, the US and Taiwan

（Million JPY）

	FY'24 Q1 Achievements	FY'24 Q2 Cumulative forecast	Q2 forecast Progress rate(%)	FY'24 Full-year forecast	Full-year forecast Progress rate (%)
Net Sales	29,288	61,474	47.6	120,784	24.2
Semi	26,836	52,099	51.5	102,399	26.2
Analysis device	331	2,373	14.0	3,841	8.6
FPD	262	3,348	7.8	6,511	4.0
Life science	152	311	49.1	1,300	11.8
※Service/Parts etc.	1,705	3,342	51.0	6,732	25.3
Operating Profit	8,748	17,298	50.6	31,617	27.7
Ordinary Profit	11,361	17,300	65.7	31,518	36.0
Attributable to parent company shareholders Quarterly (current) Net Profit	8,774	12,604	69.6	22,916	38.3

※ From the current fiscal year, "motor control equipment" is included in “Service/Parts etc.”.



Topics

Investment in Nanoverse Technologies, Ltd.

Company Profile

Name	Nanoverse Technologies, Ltd.
Location	Oregon, United States
Business Contents	Development, manufacturing and sales of semiconductor manufacturing equipment.
Establishment	July 2022
Employees	35　(As of December 31, 2023)

- Investment amount: 70 million dollars
  (approximately 11 billion yen at 158 yen/US dollar)
- Our shareholding after investment: 33% (consolidated subsidiary)
- Customer of our transfer equipment (EFEM)
- Developing new semiconductor manufacturing equipment for the advanced packaging, and planning to deliver evaluation equipment
- The impact on the business performance for this fiscal year is currently under review

Measurement



Heterodyne Optical Spectroscopy, Ellipsometry, Interferometry

Laser processing

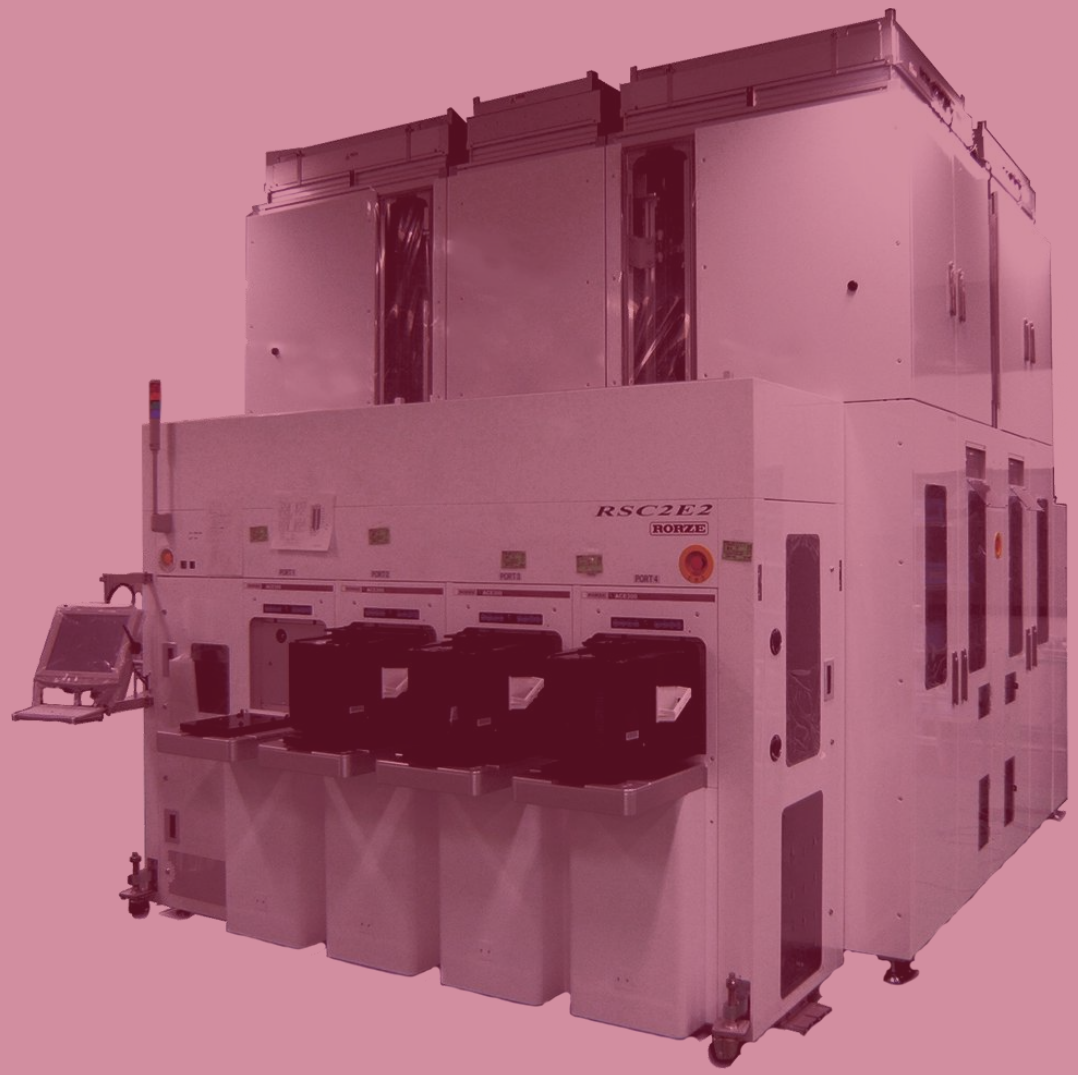


High-speed laser processing using proprietary technology

Data Intelligence



Deep understanding of automation and process development data



References

Semi

Unit



Atmospheric Robot



Aligner



Load Port

System



EFEM



Vacuum Platform

System



Wafer Sorter



N2 Purge Wafer Stocker

RORZE

Equipment manufacturers(SPE)

Process equipment

Inspection equipment

End -user

Device manufacturers

Wafer manufacturers

RORZE

Advanced packaging line

Advanced packaging

Method for connecting chiplet to achieve higher device density and functionality expansion with a smaller footprint

■ Packaging on PCB

Front-end　One chip per wafer

Previous market for RORZE's handling equipment

Back-end　One chip per package

Packaging on PCB with mounter
(Communication between each semiconductor is conducted through the PCB)

■ Packaging on Silicon Wafer

Middle-end　Instead of packaging in back-end,

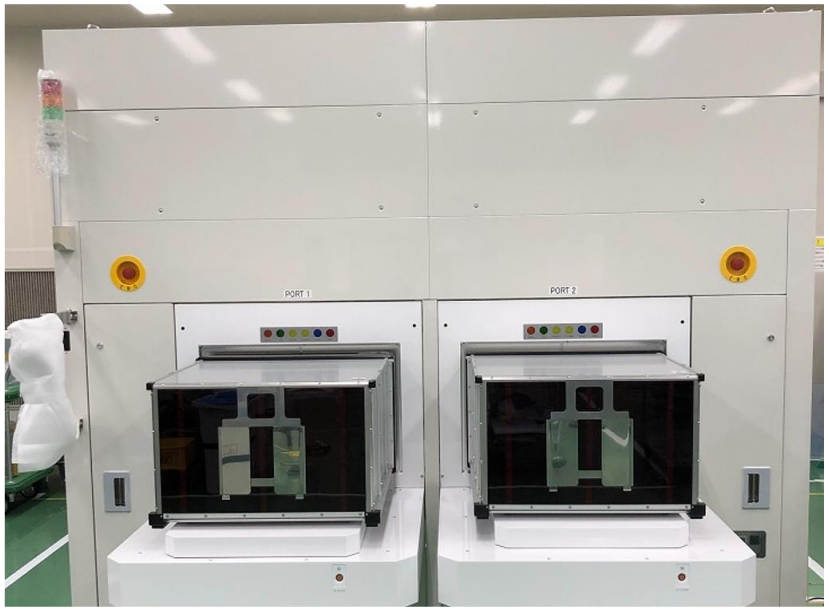
- Forming vertical holes that penetrate silicon by thinning the wafer
  (TSV：Through Silicon Via)
- **Stacking multiple wafers in 3D** on an interposer※

Expands new market, driving demand for RORZE's handling system
(Front-end＋Middle-end)

● Advanced packaging line
- Tape Frame Sorter
- PLP EFEM

※**Interposer**：A substrate that mediates the continuity of circuits on both sides through penetrating electrodes
(such as silicon interposer, glass interposer, and organic interposer)

Advanced packaging line



PLP EFEM





Tape Frame Sorter

Analysis device

IAS

Gas



GED_SEMI



GED_Q



GED



GPD

Chemical solution



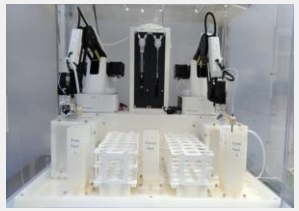
ASAS II



MSAG



CSI



ASDM

Wafer



Expert



LAGM/Expert LA

Semiconductor industry

- SPEs
- End-user
  - Device manufacturers
  - Wafer manufacturers

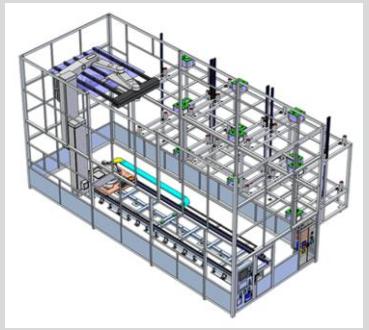
Other industry

- Research institution
- Environmental measuring
- Instrument manufacturer
- Chemical manufacturer etc.

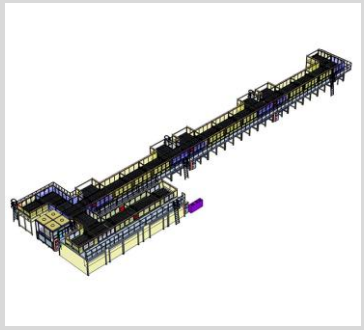
RORZE

FPD

RORZE SYSTEMS
(Subsidiary in Korea)



INDEX extra-large substrate transfer system



In-line returnable transfer system



Laser cutting equipment



Display module equipment



Cell type extra-large packing equipment

Front-end :

FPD manufacturers
Glass for FPD manufacturers

Back-end :

FPD manufacturers

Life science

RORZE Lifescience



Incubator
SCALE48



CO_2 Incubator with medium exchange function & cell imaging function
CellKeeper® II 48Plus



Mobile robot



Automatic medium exchange system
CellFarm(L)-360™



Scheduling software
Green Button Go™ ※
(※Product of Biosero)

Drug discovery, Regenerative medicine (universities, pharmaceutical companies)

RORZE

Thank you

